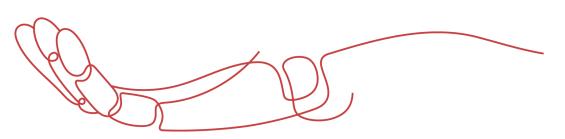




# **PRODUCT DATA SHEET**



To learn more about JGSEMI, please visit our website at







Datasheet

urces Samples

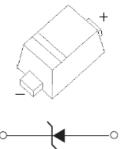
Please note: Please check the JINGAO Semiconductor website to verify the updated device numbers. The most current and up-to-date ordering information can be found at www.jg-semi.cn. Please email any questions regarding the system integration to JINGAO\_questions@jgsemi.com.



## Uni-direction ESD Protection Diode

#### **FEATURES**

- Uni-directional ESD protection of one line
- Reverse stand-off voltage: 12V
- Low reverse clamping voltage
- Low leakage current
- Excellent package:1.20mm×0.80mm×0.60mm



**SOD-523** 

- Fast response time
- JESD22-A114-B ESD Rating of class 3B per human body model
- IEC 61000-4-2 Level 4 ESD protection

## **APPLICATIONS**

- Computers and peripherals
- Digital Cameras
- Audio and video equipment
- Cellular handsets and accessories
- Portable electronics
- Mp3 Players
- Other electronics equipments communication systems



# MAXIMUM RATINGS ( $T_a$ =25°C unless otherwise noted )

Parameter			Limit	Unit	
IEC 61000-4-2 ESD Voltage	Air Model		±25		
	Contact Model	(1)	±25	kV	
JESD22-A114-B ESD Voltage Pe	er Human Body Model	V <sub>ESD</sub> <sup>(1)</sup>	±16		
ESD Voltage	Machine Model		±0.4		
Peak Pulse Power		P <sub>PP</sub> <sup>(2)</sup>	220	W	
Peak Pulse Current		I <sub>PP</sub> <sup>(2)</sup>	9	Α	
Lead Solder Temperature - Maximum (10 Second Duration)		TL	260	ပူ	
Operation Junction and Storage Temperature Range		$T_J, T_{stg}$	-55 ~ +150	$^{\circ}$	

- (1). Device stressed with ten non-repetitive ESD pulses.
- (2).Non-repetitive current pulse 8/20µs exponential decay waveform according to IEC61000-4-5.

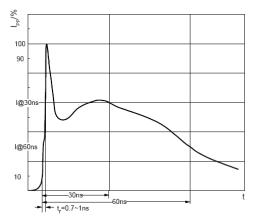
# ESD standards compliance

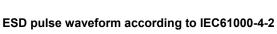
## IEC61000-4-2 Standard

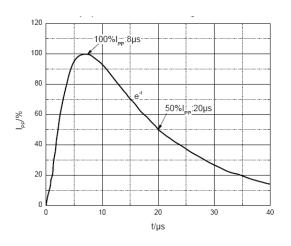
Contact Discharge		Air Discharge		
Level	Test Voltage kV	Level	Test Voltage kV	
1	2	1	2	
2	4	2	4	
3	6	3	8	
4	8	4	15	

## JESD22-A114-B Standard

Human Body Discharge V
0~249
250~499 500~999 1000~1999
2000~3999
4000∼7999 8000∼15999





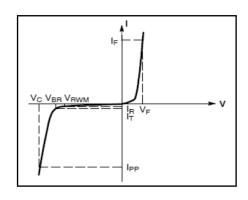


8/20µs pulse waveform according to IEC 61000-4-5



#### **ELECTRICAL PARAMETER**

Symbol	Parameter		
Vc	Clamping Voltage @ I <sub>PP</sub>		
I <sub>PP</sub>	Peak Pulse Current		
$V_{BR}$	Breakdown Voltage @ I <sub>T</sub>		
I <sub>T</sub>	Test Current		
I <sub>R</sub>	Reverse Leakage Current @ V <sub>RWM</sub>		
$V_{RWM}$	Reverse Standoff Voltage		
V <sub>F</sub>	Forward Voltage@ I <sub>F</sub>		
I <sub>F</sub>	Forward Current		



V-I characteristics for a uni-directional TVS

# ELECTRICAL CHARACTERISTICS(T $_{\underline{a}}$ =25 $^{\circ}$ C unless otherwise specified)

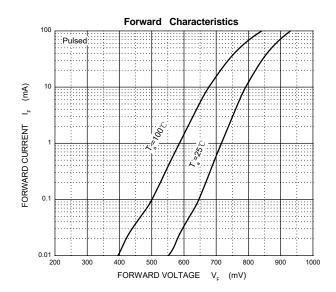
Parameter	Symbol	Test conditions	Min	Тур	Max	Unit
Reverse stand off voltage	V <sub>RWM</sub> (1)				12	V
Reverse leakage current	I <sub>R</sub>	V <sub>RWM</sub> =12V			1	μA
Breakdown voltage	V <sub>(BR)</sub>	I <sub>T</sub> =1mA	14.1		16.5	V
Clamping voltage	V <sub>C</sub> (2)	I <sub>PP</sub> =9 A			24	V
Forward voltage	V <sub>F</sub>	I <sub>F</sub> =10mA			0.9	V
Junction capacitance	C <sub>J</sub>	V <sub>R</sub> =0V,f=1MHz		45		pF

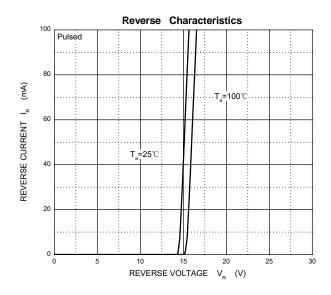
<sup>(1).</sup>Other voltages available upon request.

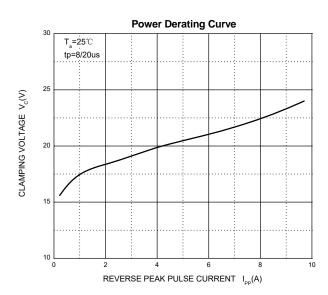
<sup>(2).</sup> Non-repetitive current pulse 8/20µs exponential decay waveform according to IEC61000-4-5

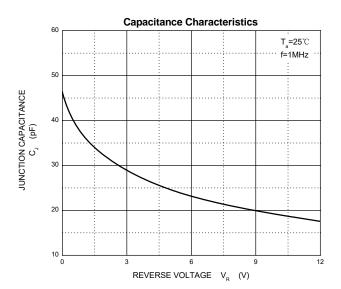


## **TYPICAL CHARACTERISTICS**





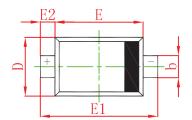


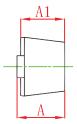


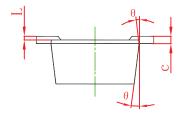


# PACKAGE OUTLINE AND PAD LAYOUT INFORMATION

# **SOD-523 Package Outline Dimensions**

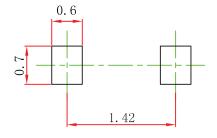






Cum al	imensions In Millimeters		imensions In Inches		
Sym ol	Min	Max	Min	Max	
Α	0.510	0.770	0.020	0.031	
A1	0.500	0.700	0.020	0.028	
b	0.250	0.350	0.010	0.014	
С	0.080	0.150	0.003	0.006	
D	0.750	0.850	0.030	0.033	
E	1.100	1.300	0.043	0.051	
E1	1.500	1.700	0.059	0.067	
E2	0.200 REF		0.008 REF		
L	0.010	0.070	0.001	0.003	
θ	7° REF		7° REF		

# **SOD-523 Suggested Pad Layout**



#### Note:

- 1. Controlling dimension:in millimeters.
- 2.General tolerance:± 0.05mm.
- 3. The pad layout is for reference purposes only.



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